

## DDR5 DIMM

TE Internal #: 6-2355632-1 DIMM Sockets, Double Data Rate (DDR) 5, Board-to-Component, 288 Position, Surface Mount, Vertical Module Orientation, DDR5 DIMM

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DRAM Type: Double Data Rate (DDR) 5

Connector System: Board-to-Component

Number of Positions: 288

Termination Method to Printed Circuit Board: Surface Mount

Module Orientation: Vertical

# Features



## **Product Type Features**

Connector & Contact Terminates To	Printed Circuit Board
DRAM Type	Double Data Rate (DDR) 5
Connector System	Board-to-Component
Configuration Features	
Number of Bays	2
Number of Keys	1
Number of Rows	2
Number of Positions	288
Module Orientation	Vertical
Electrical Characteristics	
DRAM Voltage	1.1 V
Body Features	
PCB Retention Feature Material	Stainless Steel
Ejector Material Color	Natural

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Ejector Material	High Temperature Nylon
Latch Color	Natural
Ejector Location	Both Ends
Latch Material	High Temperature Nylon
Module Key Type	DRAM
Connector Profile	Standard
Ejector Type	Rotary
Contact Features	
Memory Socket Type	Memory Card
Socket Style	DIMM
PCB Contact Termination Area Plating Material Thickness	3 μm[120 μin]
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Mating Area Plating Material	Gold
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	1.5 A



### **Termination Features**

Insertion Style	Direct Insert
Termination Post & Tail Length	.89 mm[.035 in]
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
Mount Angle	Vertical
PCB Mount Alignment Type	None
Mating Alignment Type	1 Key
Mating Alignment	With
PCB Mount Retention Type	Tab
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	High Temperature Nylon
Housing Color	Natural
Centerline (Pitch)	.85 mm[.033 in]

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## Dimensions

Profile Height from PCB	21.3 mm[.083 in]
Row-to-Row Spacing	3 mm[.118 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	High Speed Data
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	640
Packaging Method	Box & Tray
Product Compliance	
For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant

China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Compliant

## Solder Process Capability

EU ELV Directive 2000/53/EC

Not reviewed for solder process capability

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

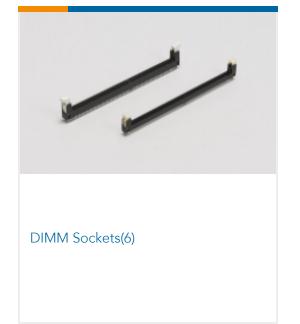
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# **Compatible Parts**



# Also in the Series DDR5 DIMM



Documents

# Product Drawings DDR5 DIMM NATURAL HSG AND NATURAL LATCH

English

## **CAD** Files

Customer View Model

ENG\_CVM\_CVM\_6-2355632-1\_A.2d\_dxf.zip

English

Customer View Model

## ENG\_CVM\_CVM\_6-2355632-1\_A.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_6-2355632-1\_A.3d\_stp.zip

English

### 3D PDF

3D

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

# **Product Specifications**

Application Specification

English

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